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Amendments to the Claims

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims

- 1. (Currently Amended) A memory cell, comprising:
 - a substrate having a substrate surface;
- a chalcogenide random access memory (CRAM) cell comprising structured to direct current through a chalcogenide structure having a cross-sectional area, which is determined by a chalcogenide deposition thin film process and by an iso-etching process and which is relatively constant throughout a length of the chalcogenide structure first side surface and a second side surface substantially perpendicular to the substrate surface, wherein the current is defined as traveling from the first side surface to second side surface; and
 - a CMOS circuit operative to access the CRAM cell.
- 2. (Original) The memory cell of claim 1, wherein the CRAM cell has cross-sectional area determined by a thin film process and by an iso-etching process.
- (Cancelled)
- 4. (Original) The memory cell of claim 1, wherein the CRAM cell further comprises a chalcogenide structure in series with a semiconductor device.
- 5. (Original) The memory cell of claim 4, wherein the semiconductor device is a diode operative to drive a current through the chalcogenide structure.

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- 6. (Original) The memory cell of claim 4, wherein the semiconductor device is a selecting transistor operative to drive a current through the chalcogenide structure when enabled by a voltage at a gate terminal of the selecting transistor.
- 7. (Original) The memory cell of claim 6, wherein:

the gate terminal of the selecting transistor is operatively coupled to a word line of a memory array;

a source terminal of the selecting transistor is operatively coupled to a drive line of the memory array; and

the drain terminal of the selecting transistor is operatively coupled to a bit line of the memory array.

- 8. (Currently Amended) A memory array, comprising:
- a plurality of chalcogenide random access memory (CRAM) cells coupled to a substrate having a substrate surface, at least one of the CRAM cells comprising a chalcogenide structure having a cross-sectional area, which is determined by a thin film process and by an iso etching process and which is relatively constant throughout a length of the chalcogenide structure with a current path, wherein the current path is defined as traveling in a direction substantially parallel with the substrate surface;
- a plurality of word lines each of which is operative to assert a data word, comprising a subset of the CRAM cells, in response to a CMOS circuit; and
- a plurality of bit lines each of which is operative to access a CRAM cell of the plurality of CRAM cells, in response to an assertion of a word line.
- 9. (Previously Presented) The memory array of claim 8, wherein each of the CRAM cells of the plurality of CRAM cells has a chalcogenide structure having a cross-sectional area, which is determined by a thin film process and by an iso-etching process and which is relatively constant throughout a length of the chalcogenide structure.

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- 10. (Previously Presented) The memory array of claim 9, wherein each of the CRAM cells of the plurality of CRAM cells has a chalcogenide structure having a cross-sectional area, which is determined by a chalcogenide deposition thin film process and by an iso-etching process and which is relatively constant throughout a length of the chalcogenide structure.
- 11. (Original) The memory array of claim 8, wherein each of the CRAM cells of the plurality of CRAM cells further comprises a chalcogenide structure in series with a semiconductor device.
- 12. (Original) The memory array of claim 11, wherein the semiconductor device is a diode operative to drive a current through the chalcogenide structure.
- 13. (Original) The memory array of claim 11, wherein the semiconductor device is a selecting transistor operative to drive a current through the chalcogenide structure when enabled by a voltage at a gate terminal of the selecting transistor.
- 14. (Original) The memory array of claim 13, wherein:

the gate terminal of the selecting transistor is operatively coupled to a word line of a memory array;

a source terminal of the selecting transistor is operatively coupled to a drive line of the memory array; and

the drain terminal of the selecting transistor is operatively coupled to a bit line of the memory array.

15-21. (Cancelled)

- 22. (New) A memory cell, comprising:
 - a substrate having a substrate surface;
- a chalcogenide random access memory (CRAM) cell structured to direct current through a chalcogenide structure having top and bottom surfaces substantially parallel to the substrate

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surface, wherein the current is defined as traveling in parallel with the top and bottom surfaces; and

a CMOS circuit operative to access the CRAM cell.